	(Rev. 10/02) OMB No. 0651-0027 (exp. 6.30,2005)
<u>ر</u>	To the Honorable Commission 1. Name of conveying party(ies):

Form PTO-1595

U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

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Name: Taiwan Semiconductor

To the Honorable Commissioner of F	inademarks: Please record the attached original documents or copy thereo
Name of conveying party(ies):	Name and address of receiving party(ies)

Burn Jeng Lin, Tsai-Sheng Gau, Chau-Kuang

Chen, Ru-Gun Liu, Shinn Sheng Yu AND Jen Chieh Shih	Manufacturing Co., Ltd. Internal Address:	
Additional name(s) of conveying party(ies) attached? 3. Nature of conveyance:	Street Address: No. 8, Li-Hsin Road 6 Science Based Industrial Park City: Hsin-Chu State: Taiwan zip: 300-77 Additional name(s) & address(es) attached? Yes X No	
A. Patent Application No.(s) Additional numbers attact	B. Patent No.(s)	
Name and address of party to whom correspondence concerning document should be mailed: Name:Howard Chen, Esq. Internal Address: Street Address:Preston Gates & Ellis LLP	6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41)\$ 40.00 X Enclosed Authorized to be charged to deposit account 8. Deposit account number: 50-3414	
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9. Signature: Howard Chen, Esq.

Reg. No.: 46,615 Name of Person Signing

Fotal number of pages including cover sheet, attachments, and documents:

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PATENT REEL: 018321 FRAME: 0611

Patent Attorney Docket No.: TSMC1434CIP/481/486/359
Attorney Reference No.: 52604-00113

ASSIGNMENT AND AGREEMENT

For value received, I/we Burn Jeng Lin, Tsai-Sheng Gau, Chun-Kuang Chen. Ru-Gun Liu, Shinn Sheng Yu and Jen Chieh Shih hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to SEAL RING ARRANGEMENTS FOR IMMERSION LITHOGRAPHY SYSTEMS described in an application for Letters Patent of the United States filed on 9-18, 2006 and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and I/we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me/us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

J/We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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PATENT REEL: 018321 FRAME: 0612 Patent Attorney Docket No.: TSMC1434CIP/481/486/359

Attorney Reference No.: 52604-00113

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I/We agree that, when requested, I/we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1:
Dated: Syt 11 20th Burn Jeng Lin
Mailing and Residence: 153 Knang In Rd Sec / Lane 89, 15t Id. CITIZENSHIP: 11.5A HSinchu Taiwan Ro
CITIZENSHIP: USA Hsinchu Tawan Ro
Inventor No. 2:
Dated: flii. 2006 / Sai-Sheng Gau
Mailing and Residence: 35, Lane 4, Ankang Stv., Heinchn city, Taiwan
CITIZENSHIP: R.O.C.
Inventor No. 3:
Dated: 9/11,2006 Chun-Kuang Chen Chun-Kuang Chen
_
Mailing and Residence: 122, Yu-shen str., kuan-Si town, Heinchu, Taiman
CITIZENSHIP: R-0-C.

Assignment and Agreement - Page 2

REEL: 018321 FRAME: 0613

Inventor No. 4:

Attorney Reference No.: 52604-00113

Dated:	Ru-Gun Liu
Mailing and Residence:	No. 9, Alley 19, Lane 452, Baashan Rd.,
Heinchu City 300	Taiwan (R.O.C.) R.O.C.
Inventor No. 5: Dated: 09/11/2006	Shinn Sheng Yu
Mailing and Residence: A	F-2, No. 16, Lane 634, Nanda Rd., Hsinchu, Townah. O.C.
Inventor No. 6:	

Assignment and Agreement - Page 3

Dated: 69/11/2006

Jen Chieh Shih

Mailing and Residence: 16F., No. 200, Dong Sec. (, Groung ming 6th Rd.,

CITIZENSHIP:

Zhubei City, Hsinchu County 302,

Taiwan (R.O.C.)

PATENT REEL: 018321 FRAME: 0614

RECORDED: 09/18/2006